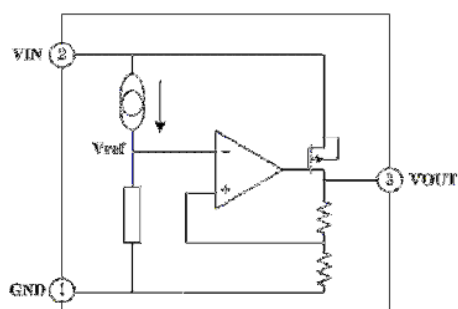


/ Descriptions

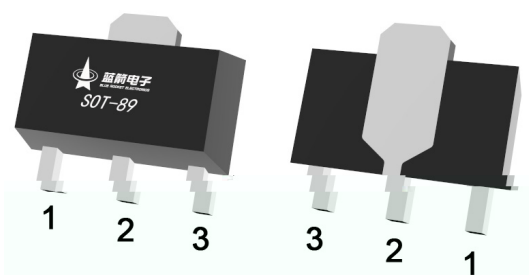
/ Features

/ Applications

/ Equivalent Circuit



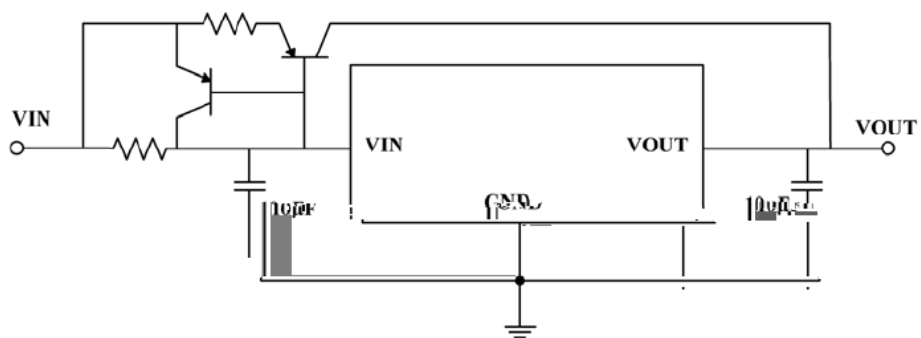
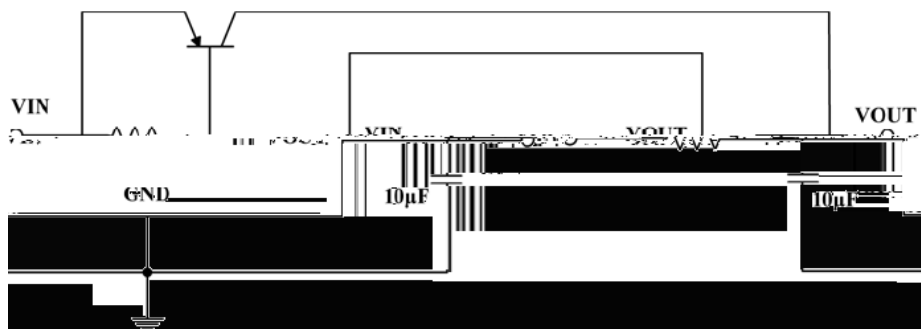
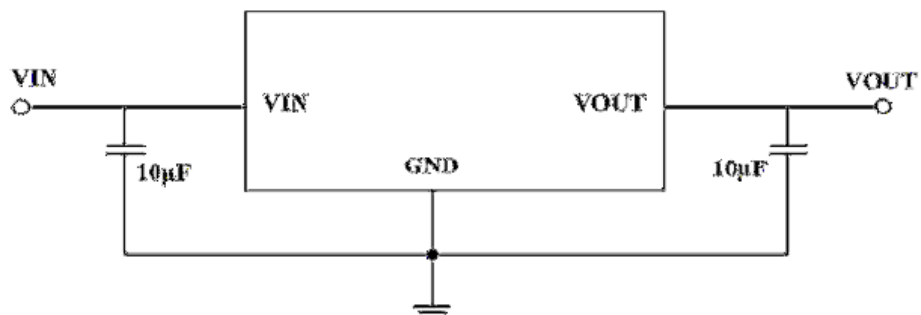
/ Pinning



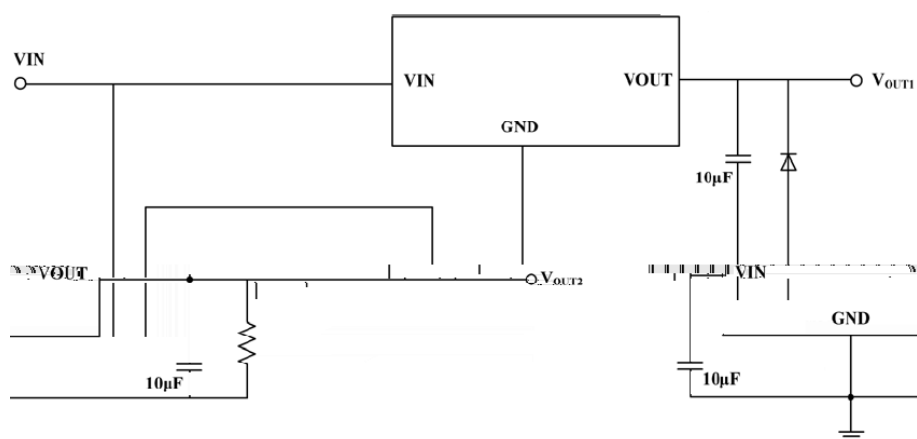
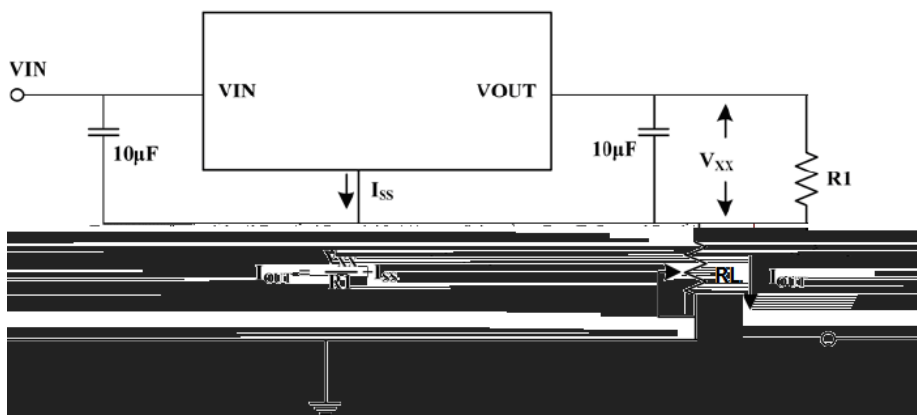
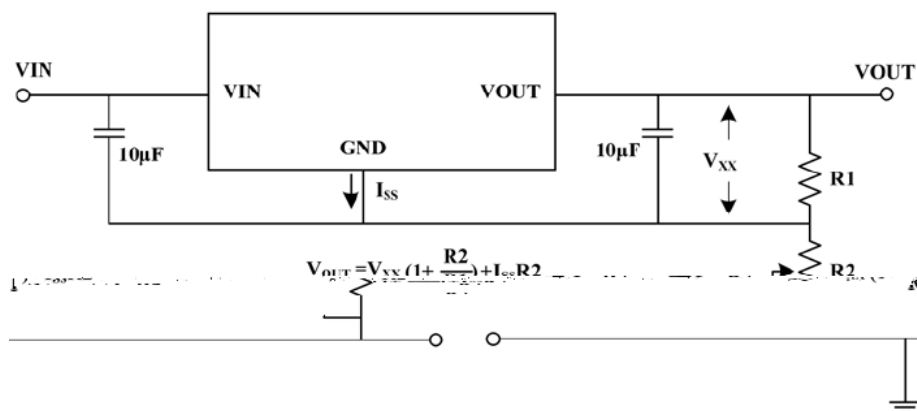
/ Marking

	θ		

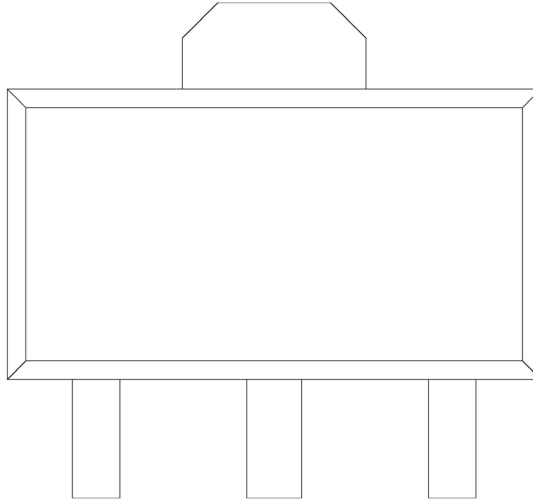
/ Typical Application Circuit



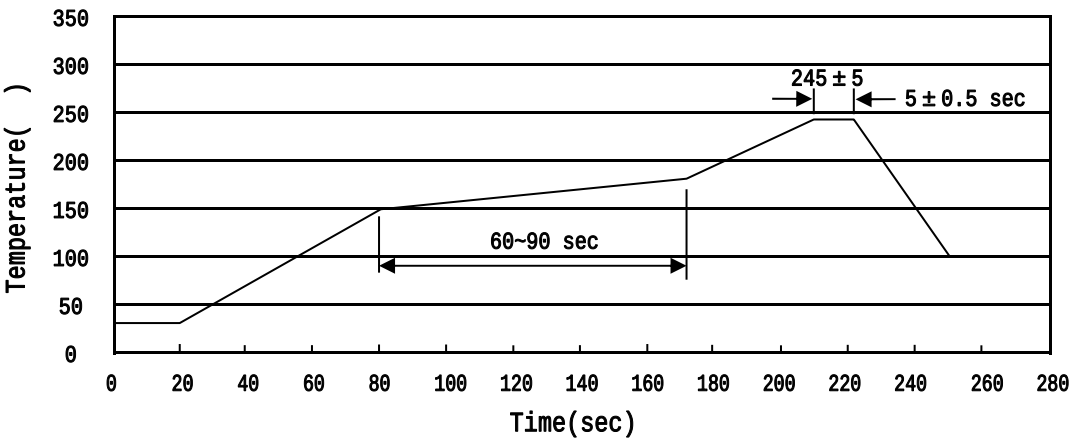
/ Typical Application Circuit



/ Marking Instructions



() / Temperature Profile for IR Reflow Soldering(Pb-Free)



/ Resistance to Soldering Heat Test Conditions

/ Packaging SPEC.

	Units/Reel /	Reels/Inner Box /	Units/Inner Box /	Inner Boxes/Outer Box /	Units/Outer Box /	Reel	Inner Box	Outer Box

/ Notices